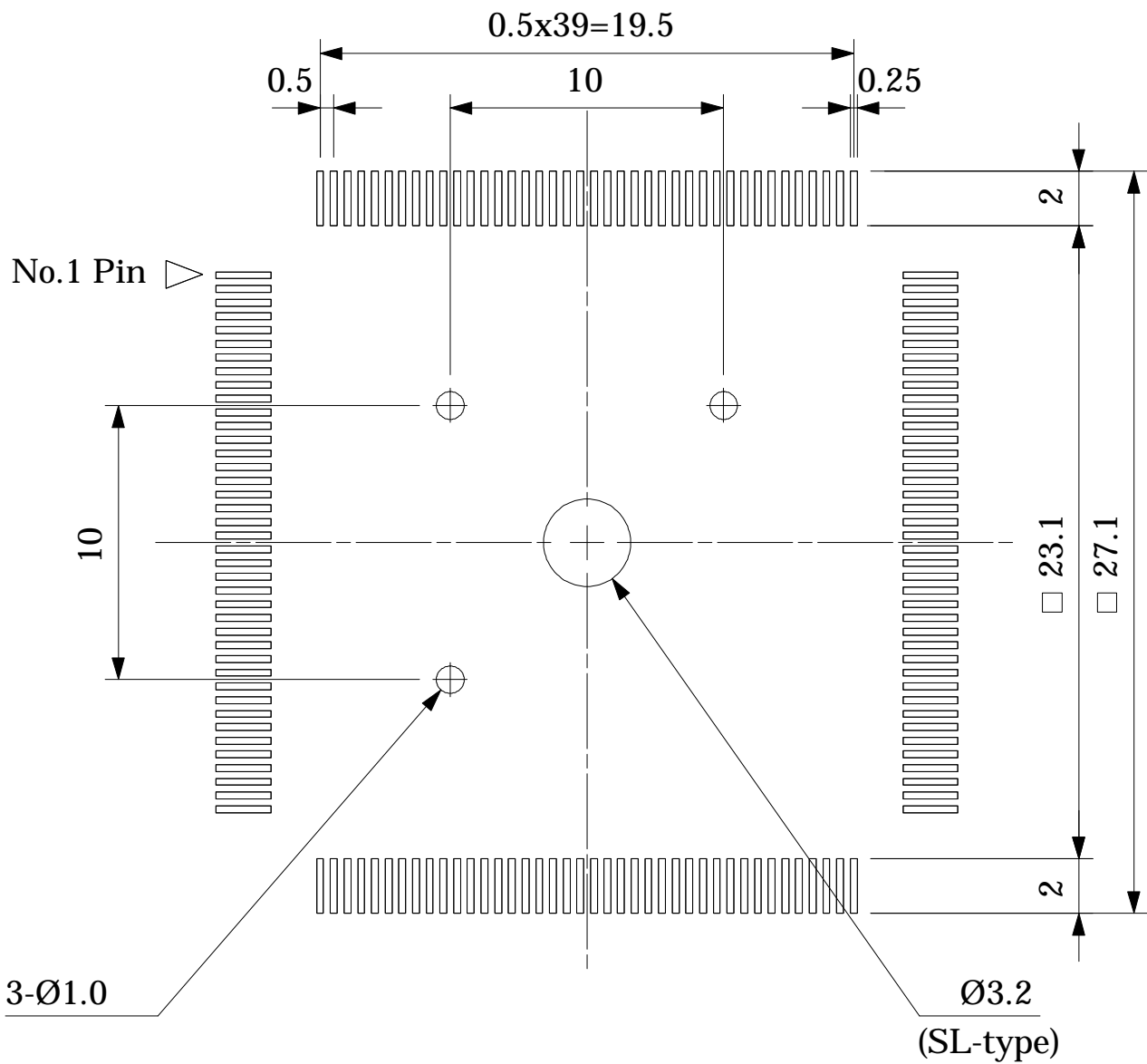


Recommended a Footprint pattern of NQPACK160SD260



* Recommended foot pattern shown on left is for NQPACK soldering.
 But please refer to IC package foot pattern recommended by IC manufacturer
 also, when the package is soldered on the same foot pattern.

| | |
|--------------------------------|-----------------------|
| Part No. | NQPACK160SD260 |
| IC package | Square |
| Pin count | 160in |
| Lead pitch | 0.5mm |
| Unit : mm | Design : M.H |
| TET TOKYO ELETECH CORP. | |